

## **DECLARATION FOR PATENT APPLICATION**

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## **COMPREHENSIVE SPOKEN LANGUAGE LEARNING SYSTEM**

the specification of which

(	) is	attached	hereto.
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- (X) was filed by an authorized person on my behalf on <u>December 31, 2003</u> as Application Serial No. 10/749,996.
- ( ) and as amended [if applicable].

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate listed below and so identified, or §365(a) of any PCT international application that designated at least one country other than the United States of America, listed below, and I have also identified below any foreign application for patent or inventor's certificate or PCT international application on this invention filed by me or my legal representatives or assigns and having a filing date before that of the application on which priority is claimed.

Priority Claimed (Yes or No)

Number N/A Country

Day/Month/Year Filed

I hereby claim benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below:

Application Serial No.

Filing Date

60/437,570

December 31, 2002

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

<u>Application Serial No.</u> <u>Filing Date</u> <u>Status</u>

N/A

PCT Application No. Filing Date

N/A

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorneys and agents, with full power of substitution and revocation, to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith and request that all correspondence and telephone calls in respect to this application be directed to David A. Hall, HELLER EHRMAN WHITE AND McAULIFFE LLP,

4350 La Jolla Village Drive, 7th Floor, San Diego, California 92122-1246; (858) 450-8400:

AttorneyReg. No.David A. Hall32,233Alan C. Gordon51,220Paul Davis29,294

and other members of the firm.

Address for correspondence: David A. Hall

HELLER EHRMAN WHITE AND McAULIFFE LLP

4350 Executive Square, 7th Floor San Diego, California 92122-1246

Full name of joint inventor: Zeev Shpiro

Inventor's signature:

Date: Feb. 8, 2004

Correspondence Address <u>27 Hata-asia Street, Industrial Area</u>

Ra'anana, Israel 43654

Residence (city, state): Ra'anana, Israel

Citizenship: Israel

•	-3	Atty Docket No. 3/818-618
Full name of joint inventor:	Eric Cohen //	
Inventor's signature:	E i ble	
Date:	Feb. 8, 2004	<del></del>
Correspondence Address	27 Hata-asia Street, Industrial Area Ra'anana, Israel 43654	
Residence (city, state):	Ra'anana, Israel	

Israel

SD 644438 v1 2/4/04 2:23 PM (37818.6189)

Citizenship: